

ABSTRACT

METHOD AND APPARATUS FOR PROCESSING
AN ARRAY OF COMPONENTS

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10 The invention provides a method and apparatus for processing an array of
electronic components. It involves providing mounting means to mount
unsingulated components onto the mounting means, singulating the components
to physically separate them, and testing the singulated electronic components for
defects whilst they are mounted on the mounting means, and without removal
therefrom.

(Figure 4)

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